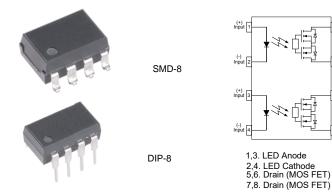
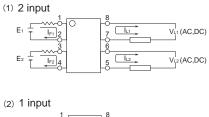
SMD-8 / DIP-8 Load Voltage:400V Load Current:150mA



Parameter	Symbol	Rating	Units	
Load Voltage	VL	400	V	
Load Current	l _L	0.15	Α	
On-Resistance	Ron	14	Ω	
I/O Breakdown Voltage	V/ıo	5000	Vrms	







V_L1 (AC,DC) V_{L2} (AC,DC)

SUPSiC PhotoRelays

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

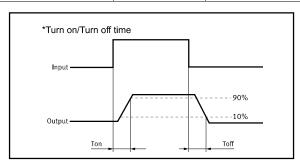
Applications

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- **Energy Management**
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Category Output Rating Load Voltage Load Current		Doolsons	Part No.	Packing Quantity	
		Package	Part No.		
AC/DC 400V 150mA	DIP-8	GAQW214E	50pcs /tube		
	15UMA	SMD-8	GAQW214EH	1000pcs /reel	





Absolute Maximum Ratings (Ta = 25°C)

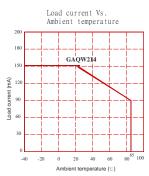
	Item	Symbol	Value	Units	Note
	Continuous LED Current	lF	50	mA	
Input	Peak LED Current	I FP	1000	mA	f=100Hz, duty=1%
·	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	Pin	75	mW	
Output	Load Voltage	V∟	400	V(AC peak or DC)	
	Load Current	IL	0.15	Α	
	Peak Load Current	Peak	0.8	А	100ms(1 pulse)
	Output Power Dissipation	Pout	750	mW	
Total Power	Dissipation	Р⊤	800	mW	
I/O Breakdov	wn Vo l tage	V _{I/O}	5000	Vrms	RH=60%, 1min
Operating Te	emperature	Topr	-40 to 85	℃	
Storage Tem	perature	T _{stg}	-40 to 100	℃	
Pin Soldering	g Temperature	T _{sol}	260	°C	10 sec max.

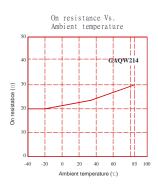
Electrical Characteristics (Ta = 25°C)

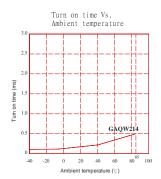
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
	LED Forward Voltage	VF	1.23	1.3	1.5	V	I⊧=10mA
	Operation LED Current	Fon		0.9	3.0	mA	
Input	Recovery LED Current	Foff		0.35	0.5	mA	
	Recovery LED Voltage	V _{Foff}	0.5	1.2		V	
							I⊧=5mA,I∟=Max
	On-Resistance	Ron		14	18	Ω	Time to flow is within 1 sec.
Output	Off-State Leakage	Leak		0.1		uA	V ₋ =Rating
	Current	Irear					VL Training
	Output Capacitance	Cout		58		pF	V∟=0, f=1MHz
Transmis	Turn-On Time	Ton		0.3	1.0	ms	I⊧=5mA, I∟=Max
sion	Turn-Off Time	Toff		0.03	0.5	ms	
Counted	I/O Isolation Resistance	R _{I/O}	10 ¹⁰			Ω	DC500V
Coupled	I/O Capacitance	Ci/o		0.8	1.5	pF	f=1MHz

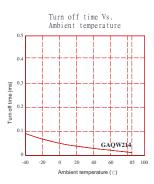
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

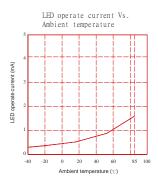
Engineering Data

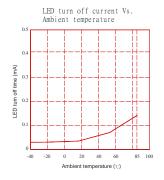


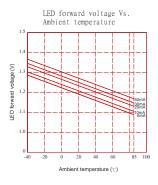


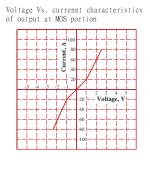


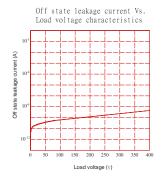


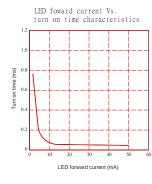


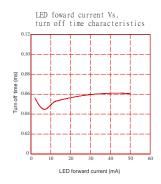


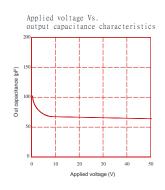










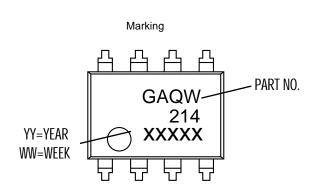


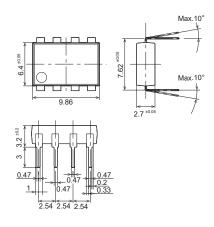


Dimensions and DIP-8 Package

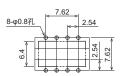
Unit: mn

Through hole terminal type





PC board pattern (Bottom view)



DIP Tape dimensions Unit: mm

Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.

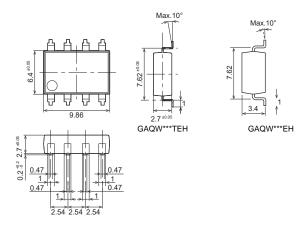




Dimensions and SMD-8 Package Unit: mm

Marking GAQW PART NO. YY=YEAR WW=WEEK WEEK

Surface mount terminal type



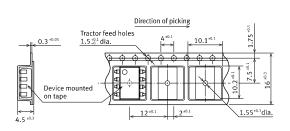
Recommended mounting pad

(Top view)

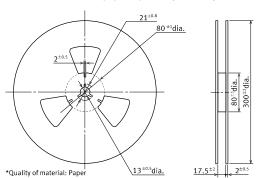


Tape dimensions (tape reel)

Tape dimensions (Unit: mm)



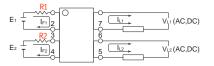
Dimensions of paper tape reel (Unit: mm)





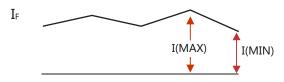
Using Methods

Examples of resistance value to control LED forward current (IF=5mA)



E1 E2	R1 R2(Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9KΩ
24V	4.1K Ω

LED forward current must be more than 5mA, at I(MIN), and less than 30mA, at I(MAX).



Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

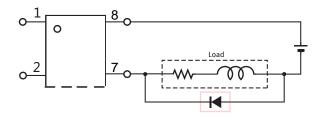
Protection Circuit

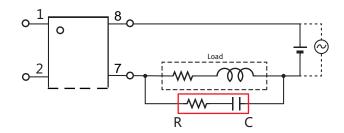
Output spike voltages:if an inductive load generates spike voltages which exceed heabsolute maximum rating, the spike voltage shall be limited.

Clamp diode is connected in parallel with the load.

Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.